

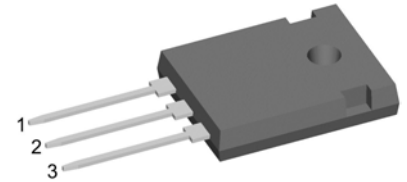
# SiC Schottky Diode

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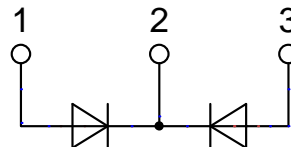
 $V_{RRM} = 1200\text{ V}$   
 $I_{FAV} = 2 \times 12.5\text{ A}$ 

Ultra fast switching  
 Zero reverse recovery  
 Common Cathode

Part number  
**DCG20C1200HR**



Backside: isolated  
 E72873



### Features / Advantages:

- Ultra fast switching
- Zero reverse recovery
- Zero forward recovery
- Temperature independent switching behavior
- Positive temperature coefficient of forward voltage
- $T_{VJM} = 175^{\circ}\text{C}$

### Applications:

- Solar inverter
- Uninterruptible power supply (UPS)
- Welding equipment
- Switched-mode power supplies
- Medical equipment
- High speed rectifier

### Package: ISO247

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Soldering pins for PCB mounting
- Backside: DCB ceramic
- Reduced weight
- Advanced power cycling

### Terms & Conditions of Usage

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact the sales office, which is responsible for you. Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

- to perform joint risk and quality assessments;

- the conclusion of quality agreements;

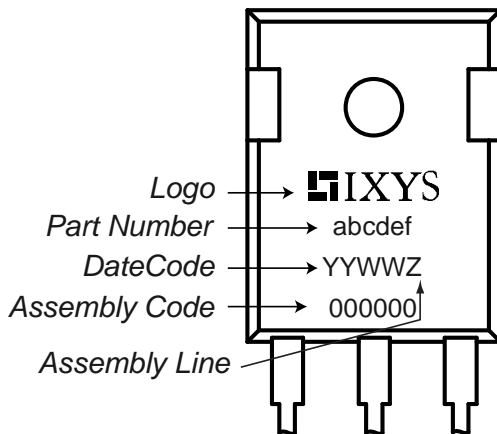
- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

| SiC Diode (per diode) |  |   |                                     | Ratings                |      |            |  |
|-----------------------|--|---|-------------------------------------|------------------------|------|------------|--|
| Symbol                | Definitions                                  | Conditions  | min.                                | typ.                   | max. |            |  |
| $V_{RSM}$             | max. non-repetitive reverse blocking voltage |   |                                     |                        | 1200 | V          |  |
| $V_{RRM}$             | max. repetitive reverse blocking voltage     |   |                                     |                        | 1200 | V          |  |
| $I_R$                 | reverse current                              | $V_R = V_{RRM}$   |                                     |                        | 30   | $\mu A$    |  |
|                       |  |   |                                     |                        | 55   | $\mu A$    |  |
| $V_F$                 | forward voltage                              | $I_F = 10 A$  |                                     |                        | 1.5  | V          |  |
|                       |  | $I_F = 20 A$  |                                     |                        | 1.8  | V          |  |
|                       |  |   |                                     |                        |      |            |  |
|                       |  | $I_F = 10 A$  |                                     |                        | 2.2  | V          |  |
|                       |  | $I_F = 20 A$  |                                     |                        | 3.0  | V          |  |
| $I_{FAV}$             | average forward current                      | $T_C = 80^\circ C$  | rectangular, d = 0.5                |                        | 12.5 | A          |  |
|                       |  | $T_C = 100^\circ C$   |                                     | $T_{VJ} = 175^\circ C$ | 11   | A          |  |
| $I_{F25}$             | forward current                              | based on typ. $V_{F0}$ and $r_F$                                    | $T_C = 25^\circ C$                  |                        | 22   | A          |  |
| $I_{F80}$             |  |   | $T_C = 80^\circ C$                  |                        | 17   | A          |  |
| $I_{F100}$            |  |   | $T_C = 100^\circ C$                 |                        | 15   | A          |  |
| $I_{FSM}$             | max forward surge current                    | t = 10 ms, half sine (50 Hz)<br>t <sub>p</sub> = 10 $\mu s$ , pulse | $T_{VJ} = 25^\circ C$<br>$V_R = 0V$ |                        |      | A          |  |
|                       |  |   |                                     |                        | 750  | A          |  |
| $V_{F0}$              | threshold voltage                            | } for power loss calculation  | $T_{VJ} = 125^\circ C$              |                        | 0.77 | V          |  |
|                       |  |   | $T_{VJ} = 175^\circ C$              |                        | 0.69 | V          |  |
| $r_F$                 | slope resistance                             |   | $T_{VJ} = 125^\circ C$              |                        | 107  | m $\Omega$ |  |
|                       |  |   | $T_{VJ} = 175^\circ C$              |                        | 133  | m $\Omega$ |  |
| $Q_C$                 | total capacitive charge                      | $V_R = 800 V, I_F = 10A$<br>di/dt = 200 A/ $\mu s$                  | $T_{VJ} = 25^\circ C$               |                        | 52   | nC         |  |
| $C$                   | total capacitance                            | $V_R = 0 V$<br>$V_R = 400 V$<br>$V_R = 800 V$                       | $T_{VJ} = 25^\circ C, f = 1 MHz$    |                        | 755  | pF         |  |
|                       |  |   |                                     |                        | 45   | pF         |  |
|                       |  |   |                                     |                        | 38   | pF         |  |
| $R_{thJC}$            | thermal resistance junction to case          | with heatsink compound; IXYS test setup                             |                                     |                        | 1.9  | K/W        |  |
| $R_{thJH}$            | thermal resistance junction to heatsink      |   | 2.2                                 | K/W                    |      |            |  |

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| Package ISO247 |                                |                                  |      | Ratings      |      |        |
|----------------|--------------------------------|----------------------------------|------|--------------|------|--------|
| Symbol         | Definitions                    | Conditions                       | min. | typ.         | max. |        |
| $I_{RMS}$      | RMS current                    | per terminal                     |      |              | 70   | A      |
| $T_{stg}$      | storage temperature            |                                  | -40  |              | 150  | °C     |
| $T_{op}$       | operation temperature          |                                  | -40  |              | 150  | °C     |
| $T_{VJ}$       | virtual junction temperature   |                                  | -40  |              | 175  | °C     |
| <b>Weight</b>  |                                |                                  |      | 6            |      | g      |
| $M_D$          | mounting torque                |                                  | 0.8  |              | 1.2  | Nm     |
| $F_C$          | mounting force with clip       |                                  | 40   |              | 120  | N      |
| $d_{Spp/App}$  | creepage distance on surface / | terminal to terminal             | 2.7  |              |      | mm     |
| $d_{Spb/Appb}$ | striking distance through air  | terminal to backside             | 4.1  |              |      | mm     |
| $V_{ISOL}$     | isolation voltage              | t = 1 second<br>t = 1 minute     |      | 3600<br>3000 |      | V<br>V |
|                |                                | 50/60 Hz; RMS; $I_{ISOL} < 1$ mA |      |              |      |        |

### Product Marking



### Part description

- D = Diode
- C = SiC
- G = Extreme fast
- 20 = Current Rating [A]
- C = Common Cathode
- 1200 = Reverse Voltage [V]
- HR = ISO247 (3)

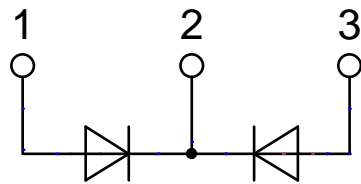
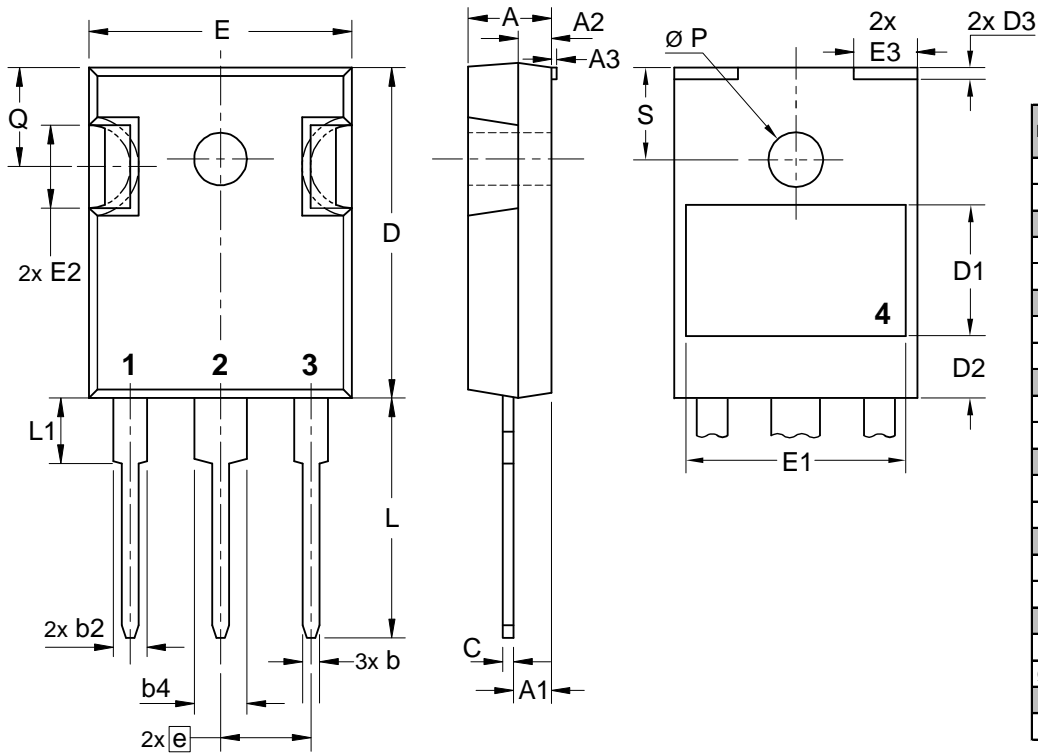
| Ordering | Part Name    | Marking on Product | Delivering Mode | Base Qty | Ordering Code |
|----------|--------------|--------------------|-----------------|----------|---------------|
| Standard | DCG20C1200HR | DCG20C1200HR       | Tube            | 30       | 522960        |

### Equivalent Circuits for Simulation \*on die level, typical

|       |                    | $T_{VJ} = 125^{\circ}\text{C}$ | $T_{VJ} = 175^{\circ}\text{C}$ |    |
|-------|--------------------|--------------------------------|--------------------------------|----|
| $V_0$ | threshold voltage  | 0.77                           | 0.68                           | V  |
| $R_0$ | slope resistance * | 107                            | 133                            | mΩ |

IXYS reserves the right to change limits, test conditions and dimensions.

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SiC Diode (per leg)

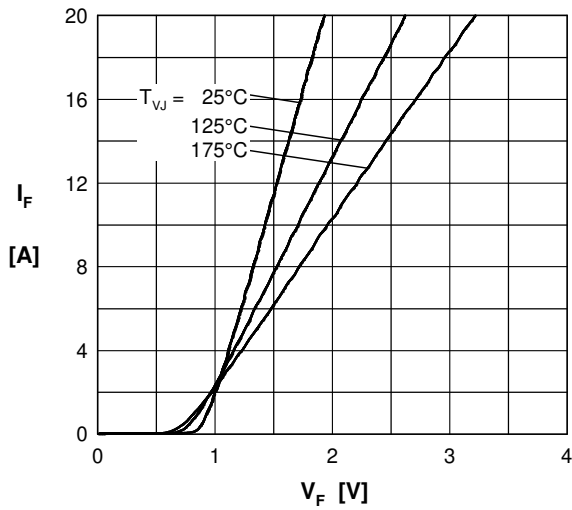


Fig. 1 Typ. forward characteristics.

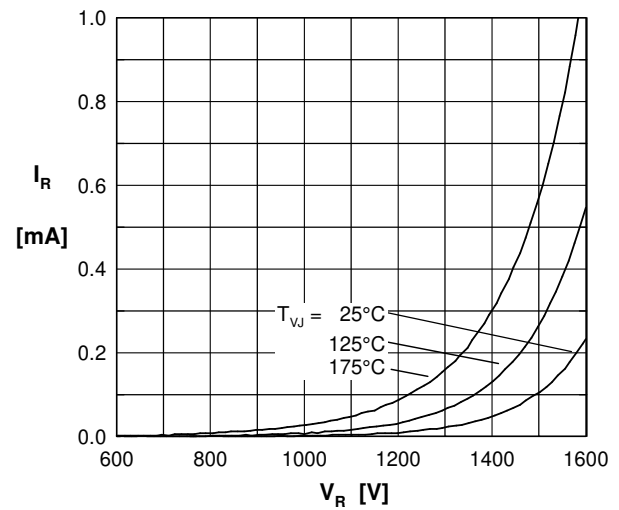


Fig. 2 Typ. reverse characteristics

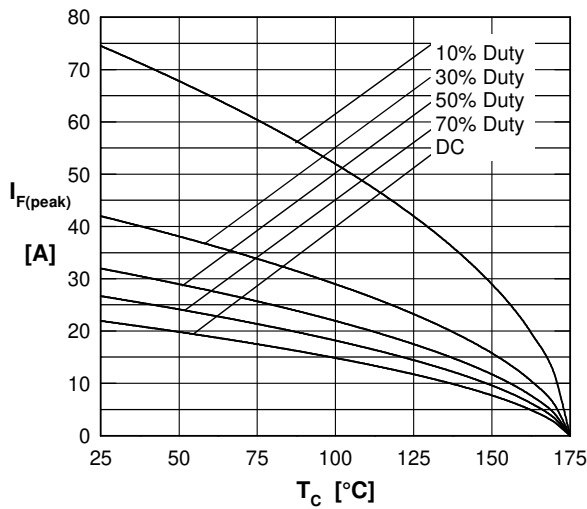


Fig. 3 Typ. current derating

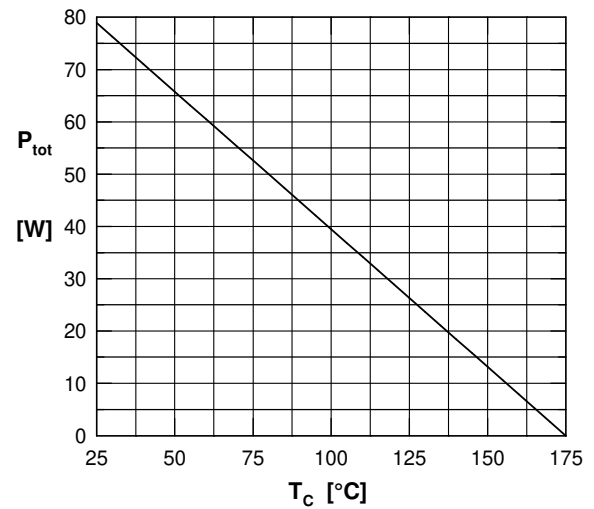


Fig. 4 Power derating

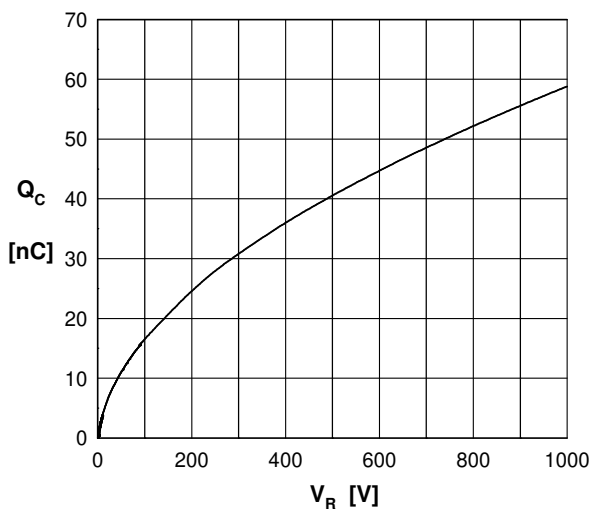


Fig. 5 Typ. recovery charge vs. reverse voltage

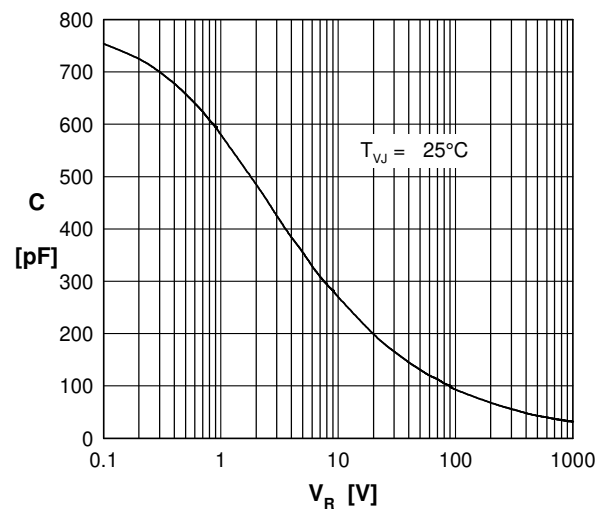


Fig. 6 Typ. junction capacitance vs. reverse Voltage

**SiC Diode (per leg)**

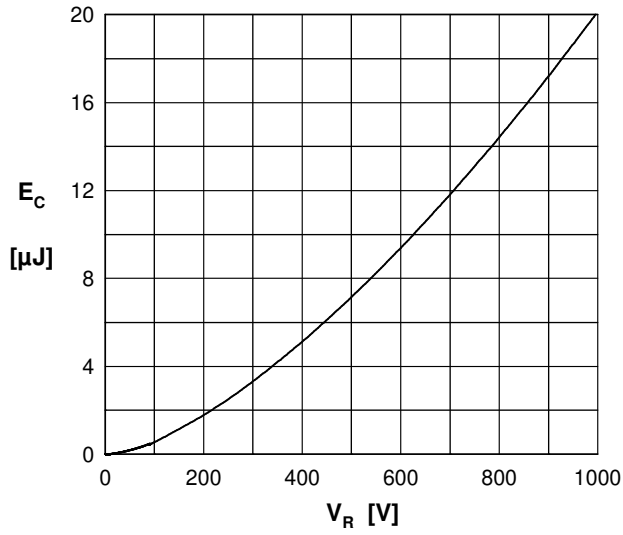


Fig. 7 Typical capacitance stored energy

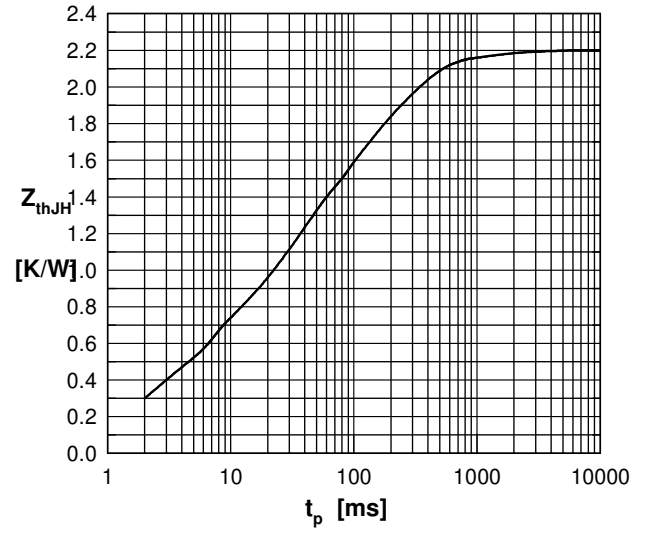


Fig. 8 Typ. transient thermal impedance